SEMICONDUCTORS

3501 ED BLUESTEIN BLVD., AUSTIN, TEXAS 78721

MICROPROCESSOR WITH CLOCK AND OPTIONAL RAM

The MC6802 is a monolithic 8-bit microprocessor that contains all the registers and accumulators of the present MC6800 plus an internal clock oscillator and driver on the same chip. In addition, the MC6802 has 128 bytes of on-board RAM located at hex addresses \$0000 to \$007F. The first 32 bytes of RAM, at hex addresses \$0000 to \$001F, may be retained in a low power mode by utilizing VCC standby; thus, facilitating memory retention during a power-down situation.

The MC6802 is completely software compatible with the MC6800 as well as the entire M6800 family of parts. Hence, the MC6802 is expandable to 64K words.

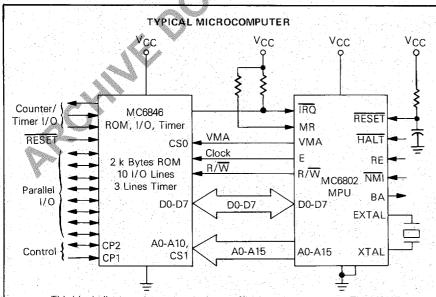
The MC6802NS is identical to the MC6802 without standby RAM feature. The MC6808 is identical to the MC6802 without on-board RAM.

- On-Chip Clock Circuit
- 128×8 Bit On-Chip RAM
- 32 Bytes of RAM are Retainable
- Software-Compatible with the MC6800
- Expandable to 64K Words
- Standard TTL-Compatible Inputs and Outputs
- 8-Bit Word Size
- 16-Bit Memory Addressing
- Interrupt Capability

PART NUMBER DESIGNATION BY SPEED

MC6802 MC6808 MC6802NS (1.0 MHz) (1.0 MHz) (1.0 MHz) MC68A02 MC68A08 (1.5 MHz) (1.5 MHz)

MC68B02 MC68B08 (2.0 MHz) (2.0 MHz)



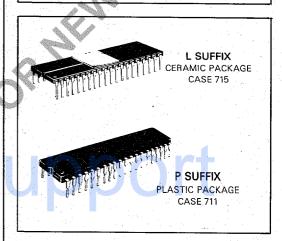
This block diagram shows a typical cost effective microcomputer. The MPU is the center of the microcoputer system and is shown in a minimum system interfacing with a ROM combination chip. It is not intended that this system be limited to this function but that it be expandable with other parts in the M6800 Microcomputer family.

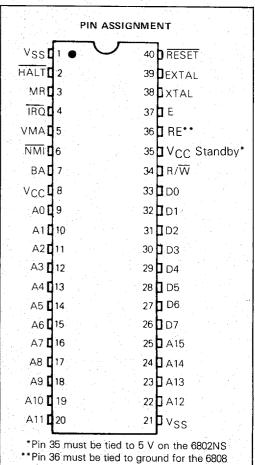
MC6802 MC6808 MC6802NS

MOS

(N-CHANNEL, SILICON-GATE, DEPLETION LOAD)

MICROPROCESSOR WITH CLOCK AND OPTIONAL RAM





MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Supply Voltage	Vcc	-0.3 to +7.0	· V
Input Voltage	Vin	-0.3 to +7.0	V
Operating Temperature Range	"ŢTA"	0 to +70	°C
Storage Temperature Range	T _{stg}	-55 to +150	°C

THERMAL CHARACTERISTICS

THE MALE CHANACIEMO 11CO	Street Miles		
Characteristic	Symbol	Value	Unit
Average Thermal Resistance (Junction to Ambient)	ilianii.	KATHARAN	
Plastic		100	00 (14)
Ceramic	₽JA′	50	°C/W

This input contains circuitry to protect the inputs against damage due to high static voltages or electric fields; however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this high-impedance circuit. Reliability of operation is enhanced if unused inputs are tied to an appropriate logic voltage level (e.g., either VSS or VCC).

POWER CONSIDERATIONS

The average chip-junction temperature, Tj, in °C can be obtained from:

$$T_{J} = T_{A} + (P_{D} \bullet \theta_{JA})$$

Where:

T_A ≡ Ambient Temperature, °C

θJA≡ Package Thermal Resistance, Junction-to-Ambient, °C/W

PD ■ PINT + PPORT

PINT≡ICC×VCC, Watts — Chip Internal Power

PPORT = Port Power Dissipation, Watts - User Determined

For most applications PPORT≪PINT and can be neglected. PPORT may become significant if the device is configured to drive Darlington bases or sink LED loads:

An approximate relationship between PD and TJ (if PPORT is neglected) is:

$$P_D = K + (T_J + 273 ^{\circ}C)$$

(2)

(1)

Solving equations 1 and 2 for K gives:

$$K = P_D \bullet (T_A + 273 \degree C) + \theta_{JA} \bullet P_D^2$$

(3)

Where K is a constant pertaining to the particular part. K can be determined from equation 3 by measuring PD (at equilibrium) for a known TA. Using this value of K the values of PD and TJ can be obtained by solving equations (1) and (2) iteratively for any value of TA.



OPERATING TEMPERATURE RANGE

Device	Speed	Symbol	Value	Unit
MC6802P,L MC6802CP,CL	(1.0 MHz) (1.0 MHz)	TA	0 to +70 -40 to +85	۰ċ
MC68A02P,L MC68A02CP,CL	(1.5 MHz) (1.5 MHz)	ТА	0 to +70 -40 to +85	°C
MC68B02P,L MC68B02CP,CL	(2.0 MHz) (2.0 MHz)	TA	0 to +70 -40 to +85	°C
MC6802NSP,L	(1.0 MHz)	TA	0 to +70	°С
MC6808P,L MC68A08P,L MC68B08P,L	(1.0 MHz) (1.5 MHz) (2.0 MHz)	TA	0 to +70	°C

DC ELECTRICAL CHARACTERISTICS (VCC=5.0 Vdc +5%, Vss=0, Ta=0 to 70°C, unless otherwise noted)

Characteristic		Symbol	Min	Тур	Max	Unit
Input High Voltage	Logic, EXTAL RESET	ViH	V _{SS} +2.0 V _{SS} +4.0		V _C C	V
Input Low Voltage	Logic, EXTAL, RESET	V _{IL}	V _{SS} -0.3	_	V _{SS} +0.8	V
Input Leakage Current (V _{in} = 0 to 5,25 V, V _{CC} = max)	Logic	lin	_	1.0	2.5	μΑ
Output High Voltage $ \begin{aligned} &(I_{Load} = -205\mu\text{A, V}_{CC} = \text{min}) \\ &(I_{Load} = -145\mu\text{A, V}_{CC} = \text{min}) \\ &(I_{Load} = -100\mu\text{A, V}_{CC} = \text{min}) \end{aligned} $	00-D7 A0-A15, R/W, VMA, E BA	Vон	Vss+2.4 Vss+2.4 Vss+2.4	- - -	 	V
Output Low Voltage (I _{Load} = 1.6 mA, V _{CC} = min)		VoL	-	_	VSS+0.4	V
Internal Power Dissipation (Measured at TA=0°C)		PINT	Ţ	0.600	1.0	W
V _{CC} Standby	Power Down Power Up	V _{SBB} V _{SB}	4.0 4.75	_	5.25 5.25	٧
Standby Current		ISBB		_	8.0	mΑ
Capacitance # $(V_{in} = 0, T_A = 25^{\circ}C, f = 1.0 \text{ MHz})$	D0-D7 Logic Inputs, EXTAL	C _{in}	- -	10 6.5	12.5 10	pF
	A0-A15, R/W, VMA	C _{out}		_	12	pF

^{*}In power-down mode, maximum power dissipation is less than 42 mW. #Capacitances are periodically sampled rather than 100% tested.

CONTROL TIMING $W_{CC} = 5.0 \text{ V } \pm 5\%$, $V_{SS} = 0$, $T_A = T_L$ to T_H , unless otherwise noted)

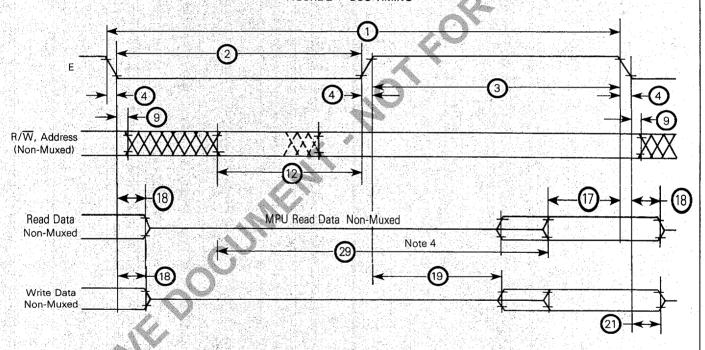
Characteristics	Symbol	MC68 MC6			8A02 8A08		8B02 8B08	Unit
		Min	Max	Min	Max	Min	Max	
Frequency of Operation	fo	0.1	1.0	0.1	1.5	0.1	2.0	MHz
Crystal Frequency	fXTAL	1.0	4.0	1.0	6.0	1.0	8.0	MHz
External Oscillator Frequency	4xf _O	0.4	4.0	0.4	6.0	0.4	8.0	MHz
Crystal Oscillator Start Up Time	trc	100	-	100	_	100	_	ms
Processor Controls (HALT, MR, RE, RESET, IRQ NMI)								
Processor Control Setup Time	tPCS	200		140		110	_	ns
Processor Control Rise and Fall Time (Does Not Apply to RESET)	tPCr, tPCf	-	100	-	100	_	100	ns



BUS TIMING CHARACTERISTICS

ldent. Number	Characteristic	Symbol	MC	802NS 6802 6808	a term for a	8A02 8A08		8B02 8B08	Unit
			Min	Max	Min	Max	Min	Max	
1	Cycle Time	tcvc	1.0	10	0.667	10	0.5	10	μS
2	Pulse Width, E Low	PWEL	450	5000	280	5000	210	5000	ns
3	Pulse Width, E High	PWEH	450	9500	280	9700	220	9700	ns
4	Clock Rise and Fall Time	t _r , t _f	1-1	25	4. - 30	25	9-3	20	ns
9	Address Hold Time	[†] AH	20		-20		20	-	ns
12	Non-Muxed Address Valid Time to E (See Note 5)	t _{AV1}	160 —	_ 270	100	Z	50 —		ns
17	Read Data Setup Time	^t DSR	100	1	70	<u> </u>	60.	94	ns
18	Read Data Hold Time	tDHR	10	148	10	-/	10	/ - ·	ns
19	Write Data Delay Time	tDDW		225) - 1%	170	1	160	ns
21	Write Data Hold Time	t _{DHW}	30		20 《	_	20		ns
29	Usable Access Time (See Note 4)	tACC	605		310	_	235		ns

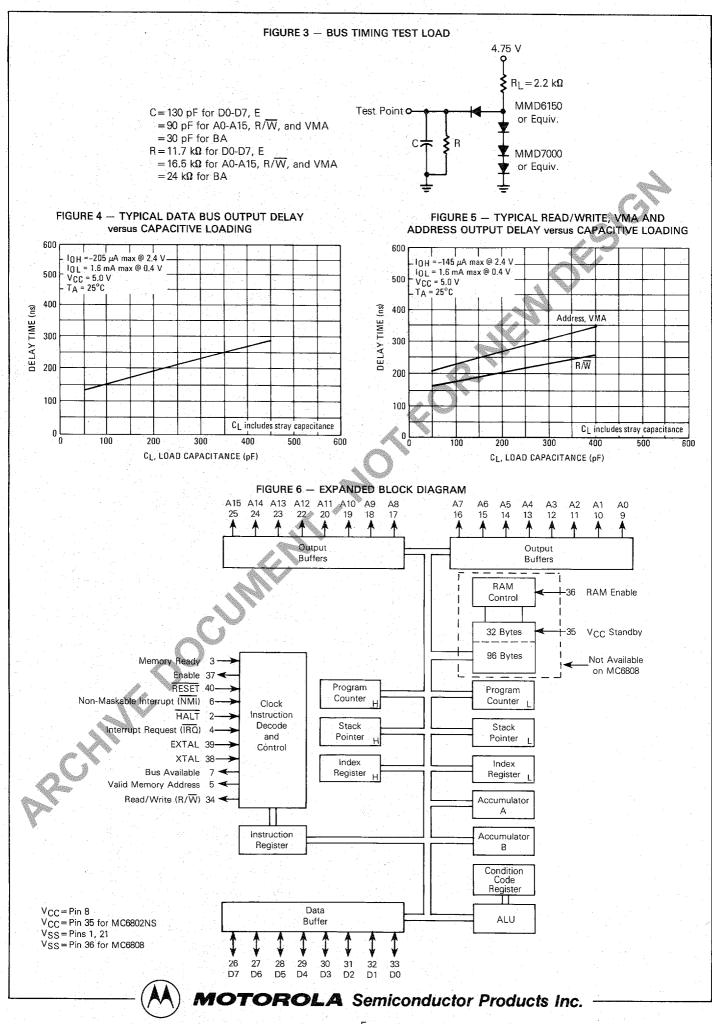
FIGURE 2 — BUS TIMING



NOTES:

- 1. Voltage levels shown are $V_L \le 0.4~V$, $V_H \ge 2.4~V$, unless otherwise specified.
- 2. Measurement points shown are 0.8 V and 2.0 V, unless otherwise noted.
- 3. All electricals shown for the MC6802 apply to the MC6802NS and MC6808, unless otherwise noted.
- 4. Usable access time is computed by: 12+3+4-17.
- 5. If programs are not executed from on-board RAM, TAV1 applies. If programs are to be stored and executed from on-board RAM, TAV2 applies. For normal data storage in the on-board RAM, this extended delay does not apply. Programs cannot be executed from on-board RAM when using A and B parts (MC68A02, MC68A08, MC68B02, MC68B08). On-board RAM can be used for data storage with all parts.





MPU REGISTERS

A general block diagram of the MC6802 is shown in Figure 6. As shown, the number and configuration of the registers are the same as for the MC6800. The 128 × 8-bit RAM* has been added to the basic MPU. The first 32 bytes can be retained during power-up and power-down conditions via the RE signal.

The MC6802NS is identical to the MC6802 except for the standby feature on the first 32 bytes of RAM. The standby feature does not exist on the MC6802NS and thus pin 35 must be tied to 5 V.

The MC6808 is identical to the MC6802 except for onboard RAM. Since the MC6808 does not have on-board RAM pin 36 must be tied to ground allowing the processor to utilize up to 64K bytes of external memory.

The MPU has three 16-bit registers and three 8-bit registers available for use by the programmer (Figure 7).

PROGRAM COUNTER

The program counter is a two byte (16-bit) register that points to the current program address.

STACK POINTER

The stack pointer is a two byte register that contains the address of the next available location in an external push-down/pop-up stack. This stack is normally a random access

read/write memory that may have any location (address) that is convenient. In those applications that require storage of information in the stack when power is lost, the stack must be non-volatile.

INDEX REGISTER

The index register is a two byte register that is used to store data or a 16-bit memory address for the indexed mode of memory addressing.

ACCUMULATORS

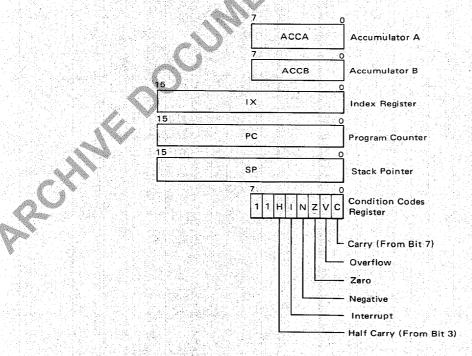
The MPU contains two 8-bit accumulators that are used to hold operands and results from an arithmetic logic unit (ALU).

CONDITION CODE REGISTER

The condition code register indicates the results of an Arithmetic Logic Unit operation: Negative (N), Zero (Z), Overflow (V), Carry from bit 7 (C), and Half Carry from bit 3 (H). These bits of the Condition Code Register are used as testable conditions for the conditional branch instructions. Bit 4 is the interrupt mask bit (I). The unused bits of the Condition Code Register (b6 and b7) are ones.

Figure 8 shows the order of saving the microprocessor status within the stack.

FIGURE 7 — PROGRAMMING MODEL OF THE MICROPROCESSING UNIT





^{*}If programs are not executed from on-board RAM, TAV1 applies. If programs are to be stored and executed from on-board RAM, TAV2 applies. For normal data storage in the on-board RAM, this extended delay does not apply. Programs cannot be executed from on-board RAM when using A and B parts (MC68A02, MC68A08, MC68B02, and MC68B08). On-board RAM can be used for data storage with all parts.

FIGURE 8 - SAVING THE STATUS OF THE MICROPROCESSOR IN THE STACK



CC = Condition Codes (Also called the Processor Status Byte)

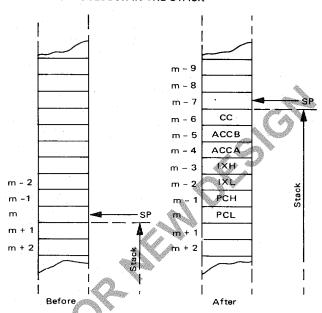
ACCB = Accumulator B

ACCA = Accumulator A IXH = Index Register, Higher Order 8 Bits

IXL = Index Register, Lower Order 8 Bits

PCH = Program Counter, Higher Order 8 Bits

PCL = Program Counter, Lower Order 8 Bits



MPU SIGNAL DESCRIPTION

Proper operation of the MPU requires that certain control and timing signals be provided to accomplish specific functions and that other signal lines be monitored to determine the state of the processor. These control and timing signals are similar to those of the MC6800 except that TSC, DBE, ϕ 1, ϕ 2 input, and two unused pins have been eliminated, and the following signal and timing lines have been added:

RAM Enable (RE)

Crystal Connections EXTAL and XTAL

Memory Ready (MR)

VCC Standby

Enable ϕ 2 Output (E)

The following is a summary of the MPU signals:

ADDRESS BUS (A0-A15)

Sixteen pins are used for the address bus. The outputs are capable of driving one standard TTL load and 90 pF. These lines do not have three-state capability.

DATA BUS (D0-D7)

Eight pins are used for the data bus. It is bidirectional, transferring data to and from the memory and peripheral devices. It also has three-state output buffers capable of driving one standard TTL load and 130 pF.

Data bus will be in the output mode when the internal RAM is accessed and RE will be high. This prohibits external data entering the MPU. It should be noted that the internal RAM is fully decoded from \$0000 to \$007F. External RAM at \$0000 to \$007F must be disabled when internal RAM is accessed.

HALT

When this input is in the low state, all activity in the machine will be halted. This input is level sensitive. In the HALT mode, the machine will stop at the end of an instruc-

tion, bus available will be at a high state, valid memory address will be at a low state. The address bus will display the address of the next instruction.

To ensure single instruction operation, transition of the HALT line must occur tpcs before the falling edge of E and the HALT line must go high for one clock cycle.

HALT should be tied high if not used. This is good engineering design practice in general and necessary to ensure proper operation of the part.

READ/WRITE (R/W)

This TTL-compatible output signals the peripherals and memory devices whether the MPU is in a read (high) or write (low) state. The normal standby state of this signal is read (high). When the processor is halted, it will be in the read state. This output is capable of driving one standard TTL load and 90 pF.

VALID MEMORY ADDRESS (VMA)

This output indicates to peripheral devices that there is a valid address on the address bus. In normal operation, this signal should be utilized for enabling peripheral interfaces such as the PIA and ACIA. This signal is not three-state. One standard TTL load and 90 pF may be directly driven by this active high signal.

BUS AVAILABLE (BA) — The bus available signal will normally be in the low state; when activated, it will go to the high state indicating that the microprocessor has stopped and that the address bus is available (but not in a three-state condition). This will occur if the HALT line is in the low state or the processor is in the WAIT state as a result of the execution of a WAIT instruction. At such time, all three-state output drivers will go to their off-state and other outputs to their normally inactive level. The processor is removed from the



WAIT state by the occurrence of a maskable (mask bit I=0) or nonmaskable interrupt. This output is capable of driving one standard TTL load and 30 pF.

INTERRUPT REQUEST (IRQ)

A low level on this input requests that an interrupt sequence be generated within the machine. The processor will wait until it completes the current instruction that is being excuted before it recognizes the request. At that time, if the interrupt mask bit in the condition code register is not set, the machine will begin an interrupt sequence. The index register, program counter, accumulators, and condition code register are stored away on the stack. Next the MPU will respond to the interrupt request by setting the interrupt mask bit high so that no further interrupts may occur. At the end of the cycle, a 16-bit vectoring address which is located in memory locations \$FFF8 and \$FFF9 is loaded which causes the MPU to branch to an interrupt routine in memory.

The HALT line must be in the high state for interrupts to be serviced. Interrupts will be latched internally while HALT is low.

A nominal 3 k Ω pullup resistor to VCC should be used for wire-OR and optimum control of interrupts. IR Ω may be tied directly to VCC if not used.

RESET

This input is used to reset and start the MPU from a power-down condition, resulting from a power failure or an initial start-up of the processor. When this line is low, the MPU is inactive and the information in the registers will be lost. If a high level is detected on the input, this will signal the MPU to begin the restart sequence. This will start execu-

tion of a routine to initialize the processor from its reset condition. All the higher order address lines will be forced high. For the restart, the last two (\$FFFE, \$FFFF) locations in memory will be used to load the program that is addressed by the program counter. During the restart routine, the interrupt mask bit is set and must be reset before the MPU can be interrupted by IRO. Power-up and reset timing and power-down sequences are shown in Figures 9 and 10, respectively.

RESET, when brought low, must be held low at least three clock cycles. This allows adequate time to respond internally to the reset. This is independent of the tree power-up reset that is required.

When RESET is released it *must* go through the low-to-high threshold without bouncing, oscillating, or otherwise causing an erroneous reset (less than three clock cycles). This may cause improper MPU operation until the next valid reset.

NON-MASKABLE INTERRUPT (NMI)

A low-going edge on this input requests that a non-maskable interrupt sequence be generated within the processor. As with the interrupt request signal, the processor will complete the current instruction that is being executed before it recognizes the $\overline{\text{NMI}}$ signal. The interrupt mask bit in the condition code register has no effect on $\overline{\text{NMI}}$.

The index register, program counter, accumulators, and condition code registers are stored away on the stack. At the end of the cycle, a 16-bit vectoring address which is located in memory locations \$FFFC and \$FFFD is loaded causing the MPU to branch to an interrupt service routine in memory.

A nominal 3 k Ω pullup resistor to VCC should be used for wire-OR and optimum control of interrupts. NMI may be tied

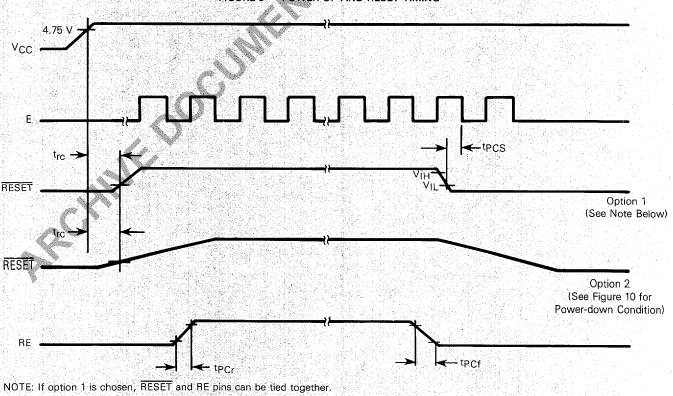


FIGURE 9 - POWER-UP AND RESET TIMING

directly to VCC if not used. Inputs $\overline{\text{IRO}}$ and $\overline{\text{NMI}}$ are hardware interrupt lines that are sampled when E is high and will start the interrupt routine on a low E following the completion of an instruction.

Figure 11 is a flowchart describing the major decision paths and interrupt vectors of the microprocessor. Table 1 gives the memory map for interrupt vectors.

TABLE 1 - MEMORY MAP FOR INTERRUPT VECTORS

Ve	ctor	
MS	LS	Description
\$FFFE	\$FFFF	Restart
\$FFFC	\$FFFD	Non-Maskable Interrupt
\$FFFA	\$FFFB	Software Interrupt
\$FFF8	\$FFF9	Interrupt Request

FIGURE 10 - POWER-DOWN SEQUENCE 4.75 V V_{CC} Ε **tCPS** ^tPCf → RE

FIGURE 11 - MPU FLOWCHART

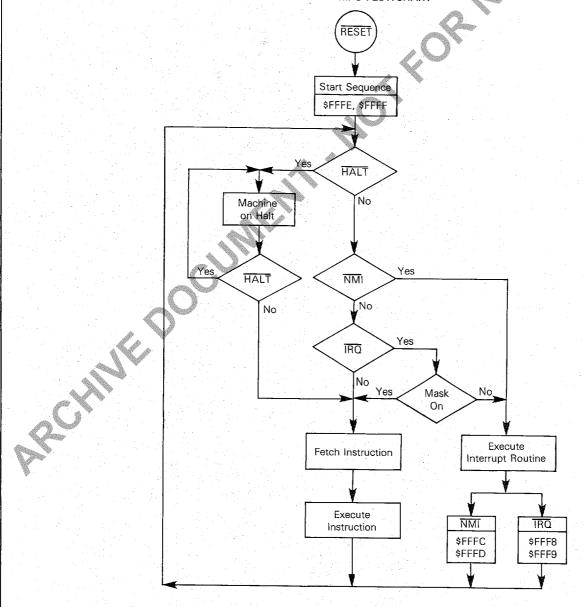
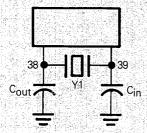


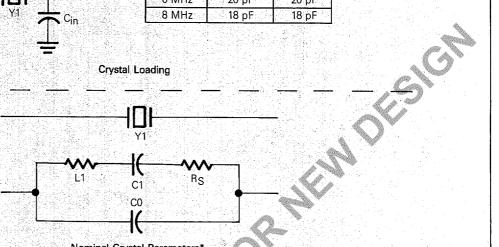


FIGURE 12 — CRYSTAL SPECIFICATIONS



100 100 100	5 N 1 N 1 N 1 N 1 N 1 N 1 N 1 N 1 N 1 N	a, an output thing the
Y1	C _{in}	Cout
3.58 MHz	27.pF	27 pF
4 MHz	27 pF	27 pF
6 MHz	20 pF	20 pF
8 MHz	18 pF	18 pF

Crystal Loading



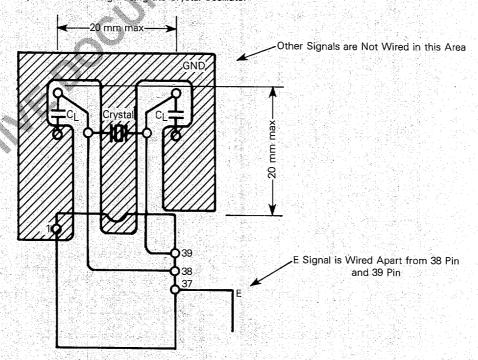
Nominal Crystal Parameters

	3.58 MHz	4.0 MHz	6.0 MHz	8.0 MHz
RS	60 Ω	50 Ω	30-50 Ω	20-40 Ω
C0	3.5 pF	6.5 pF	4-6 pF	4-6 pF
C1	0.015 pF	0.025 pF	0.01-0.02 pF	0.01-0.02 pF
0	>40K	>30K	>20K	>20K

^{*}These are representative AT-cut parallel resonance crystal parameters only. Crystals of other types of cuts may also be used.

Figure 13 - SUGGESTED PC BOARD LAYOUT

Example of Board Design Using the Crystal Oscillator





NOTOROLA Semiconductor Products Inc.



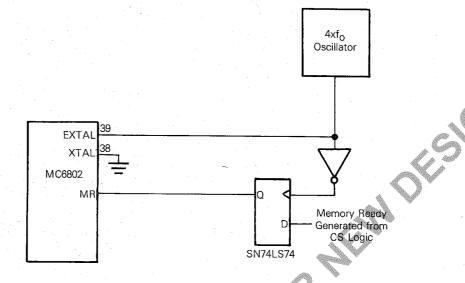
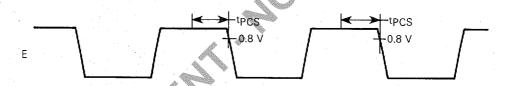


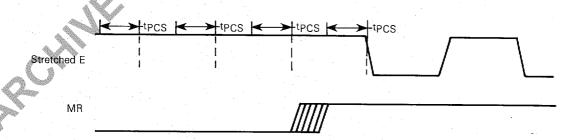
FIGURE 15 - MR NEGATIVE SETUP TIME REQUIREMENT

E Clock Stretch



The E clock will be stretched at end of E high of the cycle during which MR negative meets the tpcs setup time. The tpcs setup time is referenced to the fall of E. If the tpcs setup time is not met, E will be stretched at the end of the next E-high ½ cycle. E will be stretched in integral multiples of ½ cycles.

Resuming E Clocking



The E clock will resume normal operation at the end of the ½ cycle during which MR assertion meets the tpcs setup time. The tpcs setup time is referenced to transitions of E were it not stretched. If tpcs setup time is not met, E will fall at the second possible transition time after MR is asserted. There is no direct means of determining when the tpcs references occur, unless the synchronizing circuit of Figure 14 is used.



RAM ENABLE (RE - MC6802+ MC6802NS ONLY)

A TTL-compatible RAM enable input controls the on-chip RAM of the MC6802. When placed in the high state, the on-chip memory is enabled to respond to the MPU controls. In the low state, RAM is disabled. This pin may also be utilized to disable reading and writing the on-chip RAM during a power-down situation. RAM Enable must be low three cycles before VCC goes below 4.75 V during power-down. RAM enable must be tied low on the MC6808. RE should be tied to the correct high or low state if not used.

EXTAL AND XTAL

These inputs are used for the internal oscillator that may be crystal controlled. These connections are for a parallel resonant fundamental crystal (see Figure 12). (AT-cut.) A divide-by-four circuit has been added so a 4 MHz crystal may be used in lieu of a 1 MHz crystal for a more cost-effective system. An example of the crystal circuit layout is shown in Figure 13. Pin 39 may be driven externally by a TTL input signal four times the required E clock frequency. Pin 38 is to be grounded.

An RC network is not directly usable as a frequency, source on pins 38 and 39. An RC network type TTL or CMOS oscillator will work well as long as the TTL or CMOS output drives the on-chip oscillator.

LC networks are not recommended to be used in place of the crystal.

If an external clock is used, it may not be halted for more than $tpW_{\phi L}$. The MC6802, MC6808 and MC6802NS are dynamic parts except for the internal RAM, and require the external clock to retain information.

MEMORY READY (MR)

MR is a TTL-compatible input signal controlling the stretching of E. Use of MR requires synchronization with the 4xf₀ signal, as shown in Figure 14. When MR is high, E will be in normal operation. When MR is low, E will be stretched integral numbers of half periods, thus allowing interface to slow memories. Memory Ready timing is shown in Figure 15.

MR should be tied high (connected directly to V_{CC}) if not used. This is necessary to ensure proper operation of the part. A maximum stretch is t_{CVC}.

ENABLE (E)

This pin supplies the clock for the MPU and the rest of the system. This is a single-phase, TTL-compatible clock, This clock may be conditioned by a memory read signal. This is equivalent to $\phi 2$ on the MC6800. This output is capable of driving one standard TTL load and 130 pF.

VCC STANDBY (MC6802 ONLY)

This pin supplies the dc voltage to the first 32 bytes of RAM as well as the RAM Enable (RE) control logic. Thus, retention of data in this portion of the RAM on a power-up, power-down, or standby condition is guaranteed. Maximum current drain at VSB maximum is ISBB. For the MC6802NŚ this pin must be connected to VCC.

MPU INSTRUCTION SET

The instruction set has 72 different instructions. Included are binary and decimal arithmetic, logical, shift, rotate, load, store, conditional or unconditional branch, interrupt and stack manipulation instructions (Tables 2 through 6). The instruction set is the same as that for the MC6800.

MPU ADDRESSING MODES

There are seven address modes that can be used by a programmer, with the addressing mode a function of both the type of instruction and the coding within the instruction. A summary of the addressing modes for a particular instruction can be found in Table 7 along with the associated instruction execution time that is given in machine cycles. With a bus frequency of 1 MHz, these times would be microseconds.

ACCUMULATOR (ACCX) ADDRESSING

In accumulator only addressing, either accumulator A or accumulator B is specified. These are one-byte instructions.

IMMEDIATE ADDRESSING

In immediate addressing, the operand is contained in the second byte of the instruction except LDS and LDX which have the operand in the second and third bytes of the instruction. The MPU addresses this location when it fetches the immediate instruction for execution. These are two- or three-byte instructions.

DIRECT ADDRESSING

In direct addressing, the address of the operand is contained in the second byte of the instruction. Direct addressing allows the user to directly address the lowest 256 bytes in the machine, i.e., locations zero through 255. Enhanced execution times are achieved by storing data in these locations. In most configurations, it should be a random-access memory. These are two-byte instructions.

EXTENDED ADDRESSING

In extended addressing, the address contained in the second byte of the instruction is used as the higher eight bits of the address of the operand. The third byte of the instruction is used as the lower eight bits of the address for the operand. This is an absolute address in memory. These are three-byte instructions.

INDEXED ADDRESSING

In indexed addressing, the address contained in the second byte of the instruction is added to the index register's lowest eight bits in the MPU. The carry is then added to the higher order eight bits of the index register. This result is then used to address memory. The modified address is held in a temporary address register so there is no change to the index register. These are two-byte instructions.



IMPLIED ADDRESSING

In the implied addressing mode, the instruction gives the address (i.e., stack pointer, index register, etc.). These are one-byte instructions.

RELATIVE ADDRESSING

In relative addressing, the address contained in the second

byte of the instruction is added to the program counter's lowest eight bits plus two. The carry or borrow is then added to the high eight bits. This allows the user to address data within a range of -125 to +129 bytes of the present instruction. These are two-byte instructions.

TABLE 2 - MICROPROCESSOR INSTRUCTION SET - ALPHABETIC SEQUENCE

1						
	ABA ADC	Add Accumulators Add with Carry	CLR	Clear	PUL	Pull Data
1	ADD	Add with Carry	CLV CMP	Clear Overflow Compare	ROL	Rotate Left
	AND	Logical And	COM	Complement	ROR	Rotate Right
	ASL	Arithmetic Shift Left	CPX	Compare Index Register	RTI RTS	Return from Interrupt
	ASR	Arithmetic Shift Right	DAA	Decimal Adjust		Return from Subroutine
	BCC	Branch if Carry Clear	DEC	Decrement	SBA	Subtract Accumulators
	BCS	Branch if Carry Set	DES	Decrement Stack Pointer	SBC SEC	Subtract with Carry
	BEQ BGE	Branch if Equal to Zero	DEX	Decrement Index Register	SEI	Set Carry Set Interrupt Mask
	BGE	Branch if Greater or Equal Zero Branch if Greater than Zero	EOR	Exclusive OR	SEV	Set Overflow
1	BHI	Branch if Higher	INC	Increment	STA	Store Accumulator
	BIT	Bit Test	INS	Increment Stack Pointer	STS	Store Stack Register
	BLE	Branch if Less or Equal	INX	Increment Index Register	STX	Store Index Register
	BLS	Branch if Lower or Same	JMP	Jump	SUB SWI	Subtract
	BLT	Branch if Less than Zero	JSR	Jump to Subroutine	100	Software Interrupt
ĺ	BMI BNE	Branch if Minus Branch if Not Equal to Zero			TAB	Transfer Accumulators
	BPL	Branch if Plus	LDA LDS	Load Accumulator Load Stack Pointer	TAP TBA	Transfer Accumulators to Condition Code Reg. Transfer Accumulators
1	BRA	Branch Always	LDX	Load Index Register	TPA	Transfer Accumulators Transfer Condition Code Reg. to Accumulator
	BSR	Branch to Subroutine	LSR	Logical Shift Right	TST	Test
1	BVC BVS	Branch if Overflow Clear	NEG 🥒	Negate	TSX	Transfer Stack Pointer to Index Register
		Branch if Overflow Set	NOP	No Operation	TXS	Transfer Index Register to Stack Pointer
	CBA CLC	Compare Accumulators Clear Carry	ORA	Inclusive OR Accumulator	WAI	Wait for Interrupt
	CLI	Clear Interrupt Mask	PSH	Push Data		
1						
ľ						
1						
ŀ					Section 1	
1						
1.	Apr.					

TABLE 3 - ACCUMULATOR AND MEMORY INSTRUCTIONS

			MME	n ·		IDE.	-	DRES		ننيث	1	V.T.		· ·			BOOLEAN/ARITHMETIC OPERATION		1	_	00	
			. 25.24	- 0.70	a desire	IREC	2,8 - 1	S1000 C	NDE		20.00	XTN	1, 11, 11	111 1	IPLIE	3.4	(All register labels	5		3	2	1
DPERATIONS	MNEMONIC	OP	1	=	OP		=	OP	~	<i>i =</i>	OP.		=	OP	~	. . = ?	refer to contents)	H	1	N	z	٧
Add	ADDA	3B	2	: 2	10.14.3	3	2	AB	5	2	BB	4	3.				A + M → A	1	•	1	1	1
	ADDB	CB	2	2	DB	3	2	EB	5	2	FB	4	3	800		Ç. 1.	B + M B	1	•	1	1	1
Add Acmitrs Add with Carry	ABA			W			54.50					- 3		1B	2	- 1	A + B → A	1,1	•	1	1	1
AUD WITH CATTY	ADCA	89 C9	2	2	99	3	2	A9	5	2	89	4	3	曹镐.			A + M + C - A	1	•	1	Į.	1
And	ADCB' ANDA	84	2	2 2	D9 94	3	2	E9	- 5	2	F9	4	3				B + M + C B	. 1	•	1	1	1
	ANDB	C4	2	2	D4	3	2	A4 E4	5 5	2	B4 F4	4	3	21. 22.21.		Se.	A · M - A		•	1		R
Bit Test	BITA	85	2	2	95	3	2	A5	5	2	B5	4	3	4.5			B · M · · B A · M			1		R
	BITB	C5	2	2	D5	3	2	E5	5	2	F5	4	3	interest Laborate			B·M	ା		1		R R
Clear	CLR			47				6F	7	2	7F	6	3	34.7		1	-00 → M			R		Ä
	CLRA					The second		40.00			15.50		100	4F	2	1	00 → A	- I		R	388	À
	CLAB			44										5F	2	1	00 → B			R		
Compare	CMPA	81	2.	2	91	3	2	A1	- 5	2	B1	4	3				A-M				1.0	ī
	CMPB	C1	2	2	D1	3	2	E1	5	2	F1	4	3		300	36.	B-M	100		4	4	il
Compare Acmitrs	CBA									Lá	95			11	2	1	A – B	٠.		1	1	il
Complement, 1's	COM				1.49		ù.#	63	7	2	73	6	3				Mi→M		×		il	R
	COMA				I S			4		gr.			ýši.	43	2	1	Ā → A				· 1	R
的经济的设施品基	COMB			, bit, s						į.	I H		. 14	53	2	1	$\vec{B} \rightarrow B$			ازا	· 1	R
Complement, 2's	NEG	1.33	74				W.	60	7	2	70	6	3		N.		00 - M → M					Ö
Negate)	NEGA							V16.	048	9.3			l di	40	2	1	00 - A → A			į.		ŏ
	NEGB		48					1000	M)	4.27	130	17	15	50	2	1	00 - B - B				- 1	0
Decimal Adjust, A	DAA					医器	403			Nej.	15.7			19	2	ាំ	Converts Binary Add. of BCD Characters		1.	ì		٦
								3.5						'	-	70	into BCD Format		•	l til	1	1
Decrement	DEC	13		Š.	M.			RΔ	7	2	7A	6	3		3 3		400000		L	١. ا	٠.١	ᆁ
	DECA					包护	2.77	്		ុះគឺរ	l '"	u	ै	4.0			M - 1 → M	•	•			9
	DECB				1357		Q.	184	43						2	1	A - 1 - A	ા •	•	1	- 1.	(4)
xclusive OR	EORA	99	•	•	00									5A.	2	- 1	8 - 1 - B	•	•	1		4)
xuusive on	EORB	88	2	2	98	3	2	A8	5	2	B8	4	3	100		. All	A⊕M → A	•	•	1.	- 1	Βį
ncrement	INC	C8	2	. 2	D8	3	2	E8	5	. 2	F8	4	3			4	B⊕M→B	•	•	1	- 1.	R
increment	INCA					330		6C	7	2	7 C	6	3		4	1	M + 1 → M	ા•	•	1		<u>5</u>)
	INCA		1.74				15%		V.,					4C	2	1	A+1 → A	•	•	1	- 13	<u>5</u>
Load Acmitr	LDAA	86	2	2	96	3	,	40			0.0		2.6	5C	2	1	B + 1 - B	•	•	1		5)
Load Actility	LDAB	C6	2	2	D6	3	2	A6	5	2	86	4	3		- 58	*	. M → A	•	•	1		R
Or, Inclusive	ORAA	4 1810	2		A 100 Miles	4.0		E6	5	2	F6	4	3				M - B	•	•	1	ī	R
or, inclusive	ORAB	8A CA		2	9A DA	3	2	AA	5	2	BA	4	3 3	Mary .		-32	A + M - A	•	•	.1		R
Push Data	PSHA	UA	1		UA	3	- 5	EA	5	2	r,	4		20			B + M → B	. •	•	1	1	R
osii Data	PSHB	J-32			100						支撑	M		36	4	1	A - MSP, SP - 1 - SP	•	•	•	•	•
Pull Data	PULA	Pet				å å	40	1.1		-				37	4	1	B → M _{SP} , SP = 1 → SP	•	•	•	•	•
	PULB		40				46		A Part		20			32	4	1	SP + 1 → SP, M _{SP} — A		•	•	•	•
Rotate Left	ROL	1.39						69		2	79	6	3	33	4	1:	SP + 1 - SP, MSP - B	•	•	•	•1.	<u>.</u> 1
J. C. S. Caralles	ROLA	95.9			110		53			₩.	/3	В	3	40	्र	5,	M)	•	•	1.		9
	ROLB				IME.			100			100			49	2	1	A}		•	1		<u>@</u>
Rotate Right	ROR	Anthon		JY.	103	J. S.		66	estable.		70			59	2	1	в Ј С 67 — 60	•	•	1		⊚
wate night	RORA				1			De	7	2	76	b	3				M	: •	•	1		<u></u>
	RORB			100	- 6					Žů.				46	2	1	A } - C + D - b0	•	•	1		<u></u>
Shift Left, Arithmetic	ASL			4				68	11.00m	2	78	6	3	56	2	1		া	•	1		9
	ASLA					*		00		. *	, ,			48	2	1	M A } +		:	!		<u></u>
	ASLB	7 TO ST	486.	- 1	. **		100						6.77	58	2	1	A C b7 b0					9
Shift Right, Arithmetic	ASR	268						67	7	2	77	6	7.	30			์ พา		11.	1		9
	ASRA		423		- 67		ÇÃΣ	,			3		្ំ	47		٠٠ , ١,		- 1	•			9
	ASRB				150		330	100			13.3		3.22	57	2	1	A }		•	1		9
Shift Right, Logic	LSR		83550°	75.		100		CA	,	4		_		37	2	1	어린 수 있는 사람들은 사람들이 가는 것이 되었다.	. [•	1	2 I.	<u>(B</u>)
mire ingire, cogic						-34		04	7	2	74	6	3	47.5		14	, M	. •	•	R	1 (6
	LSRA	Section.	33)				34	900				36.1	3	44	2	1	A			R	1 (3
	LSRB		87				W			1.5				54	2	1.	B b7 b0 C			R		Š
Store Acmitr. 🧼 🗼	STAA				97	4	2	A7	6	2	B7	5	3				A M			ï		R
	STAB				D7	4	2	E7	6	2	F7		3		615		B·M			;		R
ubtract	SUBA	80	2	2		3.		AO	5	2	80		3	Md.			A M -A			1 1		
	SUBB :	СО	2	2	00	3	2	EΟ		2	FO	4	3	, line			B – M – B			1		1
Subtract Acmitrs.	SBA			. J.		315	15			38		5		10	,	1	A - B - A	세루	•	I		1
Subtr. with Carry	SBCA	82	2	2	92	3	2	A2	5	2	B2	4	3				A - M - C - A	[:			1
	SBCB		2				2	E2		2	F2	4	3	Per :			B - M - C - B	1.	:	1	2	
Fransfer Acmitrs	TAB							178		豹	L A		- [16	2	<u>.</u> 15.	A • B	1.		1	٠.	r R
	TBA		맺는	/X				S	100		18.1		343			1	B → A		•	1		R
est, Zero or Minus	TST	100	ÇH.			96		6D	7	2	70	6	3		3.1		M - 00		•	1		Ř
	TSTA	188		32				Fig	1012	Ö,		375		4D	2	1	A - 00		•	1		'n
	TSTB	150	H	ΝĬ		35	d)			44			9.5			1	B - 00			i		R
	and the second second second	1	2.10		100 00		14	1 1 1 1	100	4.50	100			10 T 1			→ Market (Market) (1) The Control of the Contro			4 1	+ 1	n I

LEGENT

- OP Operation Code (Hexadecimal);
- Number of MPU Cycles;
- = Number of Program Bytes;
- + Arithmetic Plus;
- Arithmetic Minus;
- Boolean AND;
- MSP Contents of memory location pointed to be Stack Pointer;
- + Boolean Inclusive DR;
- ⊕ Boolean Exclusive OF
- M Complement of M;
- → Transfer Into;
- 0 Bit = Zero;

Note - Accumulator addressing mode instructions are included in the column for IMPLIED addressing

CONDITION CODE SYMBOLS:

- H Half-carry from bit 3;
- l Interrupt mask
- N Negative (sign bit)
- Z Zero (byte)
- V Overflow, 2's complement C Carry from bit 7
- R Reset Always
- S Set Always
- Test and set if true, cleared otherwise
- Not Affected



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TABLE 4 — INDEX REGISTER AND STACK MANIPULATION INSTRUCTIONS

COND. CODE REG. IMMED DIRECT INDEX EXTND IMPLIED 5 4 3 2 1 0 POINTER OPERATIONS MNEMONIC OP OΡ 0P ~ æ INZVC **BOOLEAN/ARITHMETIC OPERATION** Н • 1 : 8 • Compare Index Reg 3 8 C 3 9 C 4 2 AC6 BC $X_{H} - M, X_{L} - \{M + 1\}$ • Decrement Index Reg DEX 09 X – 1 → X Decrement Stack Pntr DES $SP - 1 \rightarrow SP$ 34 1 Increment Index Reg INX 08 4 $X + 1 \rightarrow X$ Increment Stack Potr INS 31 $SP + 1 \rightarrow SP$ Load Index Req LDX CE 3 3 DE 4 EΕ FΕ 6 2 3 $M \rightarrow X_H$, $\{M + 1\} \rightarrow X_L$ 3 • • 9 Load Stack Pntr LDS 8E 3 9E 4 2 ΑE 6 2 ΒE 5 3 $M \rightarrow SP_H$, $(M + 1) \rightarrow SP_L$! R- ● Store Index Reg 2 EF 7 2 STX DF 5 FF 6 3 I R $X_H \rightarrow M, X_L \rightarrow (M + 1)$ • 9 Store Stack Pntr STS 9F 5 2 AF 7 2 BF • (9) ! R • 6 3 $SP_H \rightarrow M$, $SP_L \rightarrow (M + 1)$ Indx Reg → Stack Pritr 0 0 TXS 35 . 4 $X - 1 \rightarrow SP$ Stack Pntr → Indx Reg TSX 30 4 $SP + 1 \rightarrow X$

TABLE 5 — JUMP AND BRANCH INSTRUCTIONS

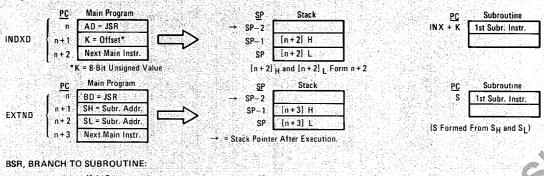
COMO CODE DEC

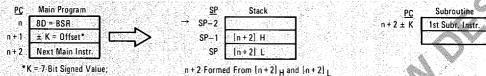
																	COM	D. C	ODE	REG	•
		RE	LAT	IVE	ı	NDE	X	Ε	XTN	D	IM	IPLIE	Đ	1		5	4	3	2	1.	0
OPERATIONS	MNEMONIC	OP	~	#	OP	~	#	OP	~	#	OP	~	#		BRANCH TEST	Н	ı	N	z	v	C
Branch Always	BRA	20	4	2											None	•	•		•	•	•
Branch If Carry Clear	BCC	24	4	2]						dir.	.486		C = 0						
Branch If Carry Set	BCS	25	4	2					1		4	6			C = 1						
Branch If = Zero	BEQ	27	4	2	1					1		1			Z = 1						
Branch If ≥ Zero	BGE	20	4	2			i		1				1		N ⊕ V = 0						
Branch If > Zero	BGT	2E	4	2		1	1.		4		Sand.		1.		$Z + (N \oplus V) = 0$						
Branch If Higher	вні	22	4	2]						b				C + Z = 0						
Branch If ≤ Zero	BLE	2F	4	2					100						$Z + (N \oplus V) = 1$						
Branch If Lower Or Same	BLS	23	4	2				4							C + Z = 1						
Branch If < Zero	BLT	20	4	2	1	4	Æ.	İ							N ⊕ V = 1						
Branch If Minus	ВМІ	28	4	2			. 1	>	i		ļ.				N = 1						
Branch If Not Equal Zero	BNE	26	4	2	. 4				İ				Ì		Z = 0		•				
Branch If Overflow Clear	BVC	28	4	2	l de	THE REAL PROPERTY.						1			V = 0						
Branch If Overflow Set	BVS	29	4	2	M.	gr.					١.	į			V = 1						•
Branch If Plus	BPL	2A	A	2	1	ĺ		ļ						ļ.	N = 0						
Branch To Subroutine	BSR	8D(8	2	100		ļ			-				1					•		
Jump	JMP -	40.	1	-	6E	- 4	2	7E	3	3			-	}	See Special Operations			•			•
Jump To Subroutine	JSR	₩	100		AD	8	2	BD	9	3			ł)	(Figure 16)			•			•
No Operation	NOP	198	1		ľ						01	, 2	1		Advances Prog. Cntr. Only	•				•	•
Return From Interrupt	AT1	Best F						İ			3B	10	1					- (<u> </u>		
Return From Subroutine	RTS	1			1						39	5	1)		•	•	•	•		•
Software Interrupt	SWI								ŀ		3F	12	1	}	See Special Operations	•	•	•		•	•
Wait for Interrupt	WAI			1.			l		ĺ	1	3E	9	1)	(Figure 16)	•	(11)				



FIGURE 16 - SPECIAL OPERATIONS

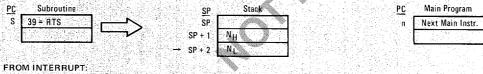
SPECIAL OPERATIONS JSR, JUMP TO SUBROUTINE:





JMP, JUMP:





RTI, RETURN FROM INTERRUPT:

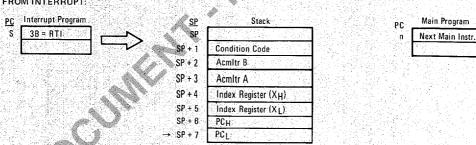


TABLE 6 — CONDITION CODE REGISTER MANIPULATION INSTRUCTIONS

							COND. CODE REG.						
		IIV	IPLIE	D.		5	4	3	2	1	0		
OPERATIONS	MNEMONIC	OP	\sim	=	BOOLEAN OPERATION	Н	1	N	z	٧	С		
Clear Carry	CLC	0.0	2	1	0 → C	•	•	•	•	•	R		
Clear Interrupt Mask	CLI	0 E	2	1	0 →1	•	R	•	•	•	•		
Clear Overflow	CLV	0A	2	1	0 → ν	•	•	•	•	R	•		
Set Carry	SEC	OD	2	1	1 → C	٠			•	•	s		
Set Interrupt Mask	SEI	0F	2	1	(•	S		•		•		
Set Overflow	SEV	OB	2	1	1 → V	•				s	•		
Acmltr A → CCR	TAP	06	2	1	A→CCR		1300	—(i	2)-				
CCR → Acmltr A	TPA	07	2	1	CCR → A	•			•	•			

CONDITION CODE REGISTER NOTES: (Bit set if test is true and cleared otherwise)

	こうしき さいしきき	승규가 없는 사람이 가장하다 함께 함께 하면서는 보고가 생활하셨다. 나는 취상에 생각하는 사람들이 가장 모양이 없다.				
	- 1 - 1 - 1 - 1 - 1 - 1 - 1 - 1 - 1 - 1	Test: Result = 10000000?	Owner.	7	(Bit N)	Test: Sign bit of most significant (MS) byte = 1?
	 Section of the property of the pr	Test: Result ≠ 00000000?		8	(Bit V)	Test: 2's complement overflow from subtraction of MS bytes?
	3 (Bit C)	Test: Decimal value of most significant BCD Character greater than nine?		9	(Bit N)	Test: Result less than zero? (Bit 15 = 1)
j.,		(Not cleared if previously set.)		10	(All)	Load Condition Code Register from Stack. (See Special Operations)
		Test: Operand = 10000000 prior to execution?		11	(Bit I)	Set when interrupt occurs. If previously set, a Non-Maskable
. !	5 (Bit V)	Test: Operand = 011111111 prior to execution?		944		Interrupt is required to exit the wait state.
. (3 (Bit V)	Test: Set equal to result of N⊕C after shift has occurred.		12	(All)	Set according to the contents of Accumulator A.



TABLE 7 — INSTRUCTION ADDRESSING MODES AND ASSOCIATED EXECUTION TIMES (Times in Machine Cycle)

	(Dual Operand)	ACCX	Immediate	Direct	Extended	Indexed	Implied	Relative			((Dual Operand)	ACCX	Immediate	Direct	Extended	lndexed	Implied
ABA ADDD ASSRCS BEGET BLS BBRSCS BBRST BBLS BBRSCS		• • • 2 2 • • • • • • • • • • • • • • •	2 2 2	3 3 3	4 4 4 6 6 6	55577	2	• • • • • • • • • • • • • • • • • • •		INC INS INX JMP JDA LDS LDX LSR NOP ORAH PULL RTI SBC SEIV STS STX		×	2 2 2	2 3 3 3	• • • • • • • • • • • • • • • • • • •	6 • 3 9 4 5 5 6 6 6 • 4 • 6 6 6 6 6	7 • 4 8 5 6 6 7 7 • 5 • • 7 7 • • 6 7 7	4 4 4 • • • • • • • • • • • • • • • • •
CLR CLV CMP COM CPX DAA DEC DES DEX EOR	x	2	• 2 • 3 • • • 2	3 4 4	6 • 4 6 5 • 6 • 4	7 • 5 7 6 • 7 • 5	• 2 • 2 • 4 4 • 4			SUB SWI TAB TAP TBA TPA TST TSX TSX WAI		×		2	3	4 • • • 6	5 • • • 7 • • •	12 2 2 2 2 2 4 4 9

NOTE: Interrupt time is 12 cycles from the end of the instruction being executed, except following a WAI instruction. Then it is 4 cycles.



SUMMARY OF CYCLE-BY-CYCLE OPERATION

Table 8 provides a detailed description of the information present on the address bus, data bus, valid memory address line (VMA), and the read/write line (R/ $\overline{\rm W}$) during each cycle for each instruction:

This information is useful in comparing actual with expected results during debug of both software and hardware

as the control program is executed. The information is categorized in groups according to addressing modes and number of cycles per instruction. (In general, instructions with the same addressing mode and number of cycles execute in the same manner; exceptions are indicated in the table.)

TABLE 8 - OPERATIONS SUMMARY

Address Mode and Instructions	Cycles	Cycle #	VMA Line	Address Bus	R/W Line	Data Bus
MMEDIATE	1574.5	HILLS.				
ADC EOR		1	1,1	Op Code Address	1	Op Code
ADD LDA AND ORA	2	2	1	Op Code Address + 1	1	Operand Data
BIT SBC						
CMP SUB						
CPX LDS		1	1	Op Code Address	1	Op Code
LDX .	3	2	1	Op Code Address + 1	1	Operand Data (High Order Byte)
DIRECT		3	1 -	Op Code Address + 2	L.1.	Operand Data (Low Order Byte)
ADC EOR		l a de la composición dela composición de la composición dela composición de la composición de la composición de la comp	I			<u> </u>
ADD LDA		1	1	Op Code Address		Op Code
AND ORA	3	2	1	Op Code Address + 1	1	Address of Operand
BIT SBC CMP SUB		3	1	Address of Operand	1	Operand Data
CPX	J. San Jan	1	1.1	Op Code Address	1	Op Code
LDS LDX	4	2	1	Op Code Address + 1	1	Address of Operand
		3	1-	Address of Operand	1	Operand Data (High Order Byte)
		4	1	Operand Address + 1	1	Operand Data (Low Order Byte)
STA		1	1	Op Code Address	. 1	Op Code
	4	2	1	Op Code Address + 1	1	Destination Address
		3	0	Destination Address	1	Irrelevant Data (Note 1)
		4	1	Destination Address	0	Data from Accumulator
STS		1 1	1	Op Code Address	1 1	Op Code
STX		2	1.	Op Code Address + 1	1	Address of Operand
	5	3 :	0	Address of Operand	1	Irrelevant Data (Note 1)
		4	1	Address of Operand	0	Register Data (High Order Byte)
		5	1	Address of Operand + 1	0	Register Data (Low Order Byte)
NDEXED			2737			
JMP		1 ,	1	Op Code Address	1	Op Code
		2		Op Code Address + 1	1	Offset
	1 7	3	0	Index Register	1	Irrelevant Data (Note 1)
		4	0	Index Register Plus Offset (w/o Carry)	1	Irrelevant Data (Note 1)
ADC EOR		1.	11	Op Code Address	1. 1.	Op Code
ADD LDA		2	1	Op Code Address + 1	1	Offset
AND ORA BIT SBC	5	3	o	Index Register	1	Irrelevant Data (Note 1)
CMP SUB	1.50	4	o	Index Register Plus Offset (w/o Carry)	1	Irrelevant Data (Note 1)
		5	1	Index Register Plus Offset	1	Operand Data
CPX		1.1	1	Op Code Address	1	Op Code
LDS LDX		2	1	Op Code Address + 1	1	Offset
	6	3	0	Index Register	1	Irrelevant Data (Note 1)
		4	0	Index Register Plus Offset (w/o Carry)	1	Irrelevant Data (Note 1)
		5	1	Index Register Plus Offset	1	Operand Data (High Order Byte)
		6		Index Register Plus Offset + 1	1	Operand Data (Low Order Byte)



TABLE 8 — OPERATIONS SUMMARY (CONCLUDED)

Address Mode and Instructions INHERENT (Continued)	Cycles	Cycle #	VMA Line	Address Bus	R/W Line	Data Bus
WAI	T	1 1	1	Op Code Address	1	Op Code
		2	1	Op Code Address + 1	1	Op Code of Next Instruction
		3	1	Stack Pointer	0	Return Address (Low Order Byte)
		4	1	Stack Pointer — 1	0	Return Address (High Order Byte)
	9	5	1	Stack Pointer — 2	0	Index Register (Low Order Byte)
		6	1	Stack Pointer – 3	0	Index Register (High Order Byte)
		7	1	Stack Pointer – 4	0	Contents of Accumulator A
		8	1	Stack Pointer — 5	0	Contents of Accumulator B
		9	1	Stack Pointer — 6	1	Contents of Cond. Code Register
RTI		1	1	Op Code Address	1	Op Code
		2	1	Op Code Address + 1	1	Irrelevant Data (Note 2)
		3	0	Stack Pointer	1	Irrelevant Data (Note 1)
		4	1	Stack Pointer + 1	1	Contents of Cond. Code Register from
		7				Stack Stack
	10	5	1	Stack Pointer + 2	1 _	Contents of Accumulator B from Stack
		6	1	Stack Pointer + 3	1	Contents of Accumulator A from Stack
		7	1	Stack Pointer + 4.	1	Index Register from Stack (High Order Byte)
		8	1.	Stack Pointer + 5	1	Index Register from Stack (Low Order Byte)
		9	1.	Stack Pointer + 6	்1	Next Instruction Address from Stack (High Order Byte)
		10	1	Stack Pointer + 7	1	Next Instruction Address from Stack (Low Order Byte)
SWI		1	1	Op Code Address	1	Op Code
		2	1	Op Code Address + 1	. 1	Irrelevant Data (Note 1)
		3	1	Stack Pointer	0	Return Address (Low Order Byte)
		4	1	Stack Pointer - 1	0	Return Address (High Order Byte)
		5	1	Stack Pointer — 2	0	Index Register (Low Order Byte)
	12	6	1.	Stack Pointer - 3	0	Index Register (High Order Byte)
		7	1	Stack Pointer — 4	0	Contents of Accumulator A
		8	1	Stack Pointer - 5	0	Contents of Accumulator B
	es de la	9	1	Stack Pointer — 6	0	Contents of Cond. Code Register
		10	0	Stack Pointer — 7	1	Irrelevant Data (Note 1)
		11	1	Vector Address FFFA (Hex)	1.	Address of Subroutine (High Order Byte)
		12	1	Vector Address FFFB (Hex)	1	Address of Subroutine (Low Order Byte)
RELATIVE			1 <u>1 </u>			
BCC BHI BNE BCS BLE BPL		1	1	Op Code Address	1	Op Code
BEQ BLS BRA	4	2	1	Op Code Address + 1	1	Branch Offset
BGE BLT BVC BGT BMI BVS		3	0	Op Code Address + 2	1	Irrelevant Data (Note 1)
		4	0 0	Branch Address	1	Irrelevant Data (Note 1)
BSR		1	1	Op Code Address	1	Op Code
		2	1.	Op Code Address + 1	1	Branch Offset
		3	0	Return Address of Main Program	1	Irrelevant Data (Note 1)
	8	4	1	Stack Pointer	0	Return Address (Low Order Byte)
		5	1	Stack Pointer — 1	О	Return Address (High Order Byte)
		6	0	Stack Pointer — 2	1	Irrelevant Data (Note 1)
		7	0	Return Address of Main Program	1	Irrelevant Data (Note 1)
		8	0	Subroutine Address (Note 4)	1	Irrelevant Data (Note 1)

NOTES:

- 1. If device which is addressed during this cycle uses VMA, then the Data Bus will go to the high-impedance three-state condition. Depending on bus capacitance, data from the previous cycle may be retained on the Data Bus.

 2. Data is ignored by the MPU.
- 3. For TST, VMA=0 and Operand data does not change.
- 4. MS Byte of Address Bus = MS Byte of Address of BSR instruction and LS Byte of Address Bus = LS Byte of Sub-Routine Address.

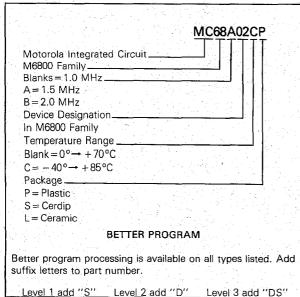


TABLE 8 - OPERATIONS SUMMARY (CONTINUED)

Address Mode and Instructions	Cycles	Cycle #	VMA Line	Address Bus	R/W Line	Data Bus
EXTENDED (Continued)						
STS	ward)	1.1	板机厂	Op Code Address	14, 2, 1 (, 1 4)	Op Code
STX		2	1:	Op Code Address + 1	[] 1	Address of Operand (High Order Byte)
	6	3 -	1.	Op Code Address + 2	9 - 1 - 1	Address of Operand (Low Order Byte)
		4	l o l	Address of Operand	1. 1. 1. 1. 1. 1. 1. 1. 1. 1. 1. 1. 1. 1	Irrelevant Data (Note 1)
		5	1	Address of Operand	o	Operand Data (High Order Byte)
		6	1	Address of Operand + 1	o	Operand Data (Low Order Byte)
JSR	office (Brown) Described Executive (Brown)		101	Op Code Address		Op Code
		2		Op Code Address + 1		Address of Subroutine (High Order Byte
		3	1	Op Code Address + 2		Address of Subroutine (Low Order Byte
		4	1	Subroutine Starting Address	1	Op Code of Next Instruction
	9	5	1	Stack Pointer		Return Address (Low Order Byte)
	.	6	Hi	Stack Pointer — 1	0	Return Address (High Order Byte)
		144			skind i kalendari	
		7	0	Stack Pointer — 2	1	Irrelevant Data (Note 1)
		8.	0	Op Code Address + 2	1	Irrelevant Data (Note 1)
	Salas Milli	9.	1	Op Code Address + 2	1.5	Address of Subroutine (Low Order Byte
NHERENT				Programme with the state of the		
ABA DAA SEC	3,451.43	17	144	Op Code Address		Op Code
ASL DEC SEI	2	2	1	Op Code Address + 1	1	Op Code of Next Instruction
ASR INC SEV CBA LSR TAB						
CLC NEG TAP		Horrist Friday				
CLI NOP TBA						
CLR ROL TPA CLV ROR TST		700				
COM SBA	SEE VIEW	Asset Sac				
DES DEX	Past	1	1.1.	Op Code Address	1 .	Op Code
NS	4	2	1.71	Op Code Address + 1		Op Code of Next Instruction
INX		3	0	Previous Register Contents	(1) (1) (1) (1) (1) (1) (1) (1) (1) (1)	Irrelevant Data (Note 1)
		4	0	New Register Contents	1.	Irrelevant Data (Note 1)
PSH	N. H.	1	1.	Op Code Address	1	Op Code
	4	2	131	Op Cade Address + 1	. 1	Op Code of Next Instruction
	F 151	3 -	11	Stack Pointer	0	Accumulator Data
		4	O	Stack Pointer — 1	1.5	Accumulator Data
PUL .	1939 F.S.	1	1	Op Code Address	14.00	Op Code
		2	1	Op Code Address + 1		Op Code of Next Instruction
	4	3	0	Stack Pointer		Irrelevant Data (Note 1)
				Stack Pointer + 1		Operand Data from Stack
	2-140 (56-6 54-15 (56-6	4		PART TO A STATE OF THE STATE OF		
TSX		1	1	Op Code Address	h 1 1 5	Op Code
	4	2	1	Op Code Address + 1		Op Code of Next Instruction
		3	0	Stack Pointer		Irrelevant Data (Note 1)
		4	0,	New Index Register	1	Irrelevant Data (Note 1)
TXS		11	1	Op Code Address	1-1-	Op Code
	4	2	10	Op Code Address + 1	1.	Op Code of Next Instruction
		. 3	0	Index Register	1	Irrelevant Data
		4	0	New Stack Pointer		Irrelevant Data
RTS		10	11	Op Code Address	1.5	Op Code
		2.	11	Op Code Address + 1	1	Irrelevant Data (Note 2)
	5	3	0	Stack Pointer		Irrelevant Data (Note 1)
		4	1			
		'		Stack Pointer + 1		Address of Next Instruction (High Order Byte)
		5	1	Stack Pointer + 2		Address of Next Instruction (Low
a kanada ila dakaran babasa Perti	Laboration	1		COUNT UNITED 1.4		Order Byte)

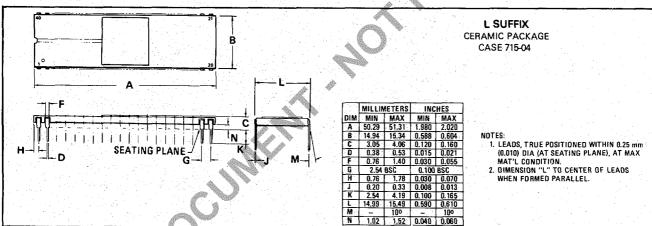


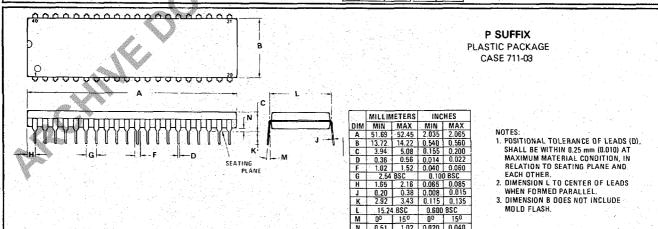
ORDERING INFORMATION



Level 1 "S" = 10 Temp Cycles — (-25 to 150°C);
Hi Temp testing at T_A max.
Level 2 "D" = 168 Hour Burn-in at 125°C
Level 3 "DS" = Combination of Level 1 and 2.

PACKAGE DIMENSIONS





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MOTOROLA Semiconductor Products Inc.

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TABLE 8 — OPERATIONS SUMMARY (CONTINUED)

Address Mode and Instructions	Cycles	Cycle #	VMA Line	Address Bus	R/W Line	Data Bus
INDEXED (Continued)		15 T. A.			7	
STA		1.5	1	Op Code Address	1	Op Code
		2	1.4	Op Code Address + 1	1	Offset
	6	3	0 -	Index Register	1	Irrelevant Data (Note 1)
	- din	4	o .	Index Register Plus Offset (w/o Carry)	1	Irrelevant Data (Note 1)
		5	0	Index Register Plus Offset	idas 154 Sa 1 Jac	Irrelevant Data (Note 1)
		6	1.1	Index Register Plus Offset	0	Operand Data
ASL LSR	La ANT	∛n - 1 (2	1	Op Code Address	3.41	Op Code
ASR NEG		2	1	Op Code Address + 1	1	Offset
CLR ROL COM ROR	7	3	o	Index Register	41	Irrelevant Data (Note 1)
DEC TST		4	o .	Index Register Plus Offset (w/o Carry)	1	Irrelevant Data (Note 1)
INC		5	1	Index Register Plus Offset	1	Current Operand Data
	4.495	6	o	Index Register Plus Offset	1	Irrelevant Data (Note 1)
		7	1/0	Index Register Plus Offset	0	New Operand Data (Note 3)
			(Note			New Operand Data (Note 3)
	数型点接近	5	3)			
STS		1		Op Code Address	1	Op Code
STX		2		Op Code Address + 1	1	Offset
	7	3	0	Index Register	1	Irrelevant Data (Note 1)
	to F	4	0	Index Register Plus Offset (w/o Carry)	1	Irrelevant Data (Note 1)
		5	0	Index Register Plus Offset		Irrelevant Data (Note 1)
		6.		Index Register Plus Offset	0	Operand Data (High Order Byte)
		7	1.5	Index Register Plus Offset + 1	0	Operand Data (Low Order Byte)
JSR	4. 10. 10. 11. 14. 1 20. 11. 14. 1	10 11 11 11 11 11 11 11 11 11 11 11 11 1	100	A Carlos Medicks where the control of the control o	. 1	
3311		2	1.5	Op Code Address		Op Code
	はなる。	\$4.75 DES		Op Code Address + 1	1.4	Offset
		3	0.	Index Register	1	Irrelevant Data (Note 1)
	8,	4	1	Stack Pointer	0	Return Address (Low Order Byte)
		5	1	Stack Pointer — 1	0	Return Address (High Order Byte)
		. 6	0	Stack Pointer — 2	1	Irrelevant Data (Note 1)
		7	0 .	Index Register	1.3	Irrelevant Data (Note 1)
EXTENDED	Siece deservi	8	0	Index Register Plus Offset (w/o Carry)	1	Irrelevant Data (Note 1)
The first of the control of the first of the control of the contro	Capacas	rice van Norda Ai	1.4	6.0.1.011	1	로 발가 워크를 취임하는 하는 사람들이 보는 것으로 보는 것으로 되었다. 영화 보고 있으로 하는 것으로 함께 되었다.
JMP				Op Code Address	1	Op Code
	3	1. 2 ⊨	1 -	Op Code Address + 1	1	Jump Address (High Order Byte)
		3	1	Op Code Address + 2	1	Jump Address (Low Order Byte)
ADC EOR		. 1	1	Op Code Address	1	Op Code
ADD LDA		2	1.	Op Code Address + 1	1	Address of Operand (High Order Byte
AND ORA BIT SBC	4	3	1.1	Op Code Address + 2	1	Address of Operand (Low Order Byte
CMP SUB		4	1.1	Address of Operand	1	Operand Data
CPX		1.	1.11	Op Code Address	1	Op Code
LDS LDX		2	1	Op Code Address + 1	1	Address of Operand (High Order Byte
	5	3	111	Op Code Address + 2	1	Address of Operand (Low Order Byte
		4	1.	Address of Operand	1	Operand Data (High Order Byte)
		5	131	Address of Operand + 1	1	Operand Data (Low Order Byte)
STA A	Madia	1	11	Op Code Address	1.1.	Op Code
STA B		2	1	Op Code Address + 1	1	Destination Address (High Order Byt
	5	3		Op Code Address + 2	1	Destination Address (Low Order Byte
		4	0	Operand Destination Address	1	Brandard and Salaran and Francisco
			1	Apple	1 30 3 4 3	Irrelevant Data (Note 1)
ACL LCD		5	than agents.	Operand Destination Address	0	Data from Accumulator
ASL LSR ASR NEG		- 1 -	1.	Op Code Address	1.	Op Code
CLR ROL		2	11.	Op Code Address + 1	1	Address of Operand (High Order Byte
COM ROR	- 6	- 3	1.	Op Code Address + 2	1.1	Address of Operand (Low Order Byte
DEC TST INC		4	1	Address of Operand	1.1	Current Operand Data
		5	. 0	Address of Operand	1	Irrelevant Data (Note 1)
· · · · · · · · · · · · · · · · · · ·	Barra Markett	Liver Line	1 200		1	BASEL : 이번 전 및 전 후 전 - 전 기도 회
민건물하는 등 마루미탈 개류로 화를		6	1/0 (Note	Address of Operand	0	New Operand Data (Note 3)

